

08-24-2000



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To the Honorable Commissioner of Patents and Trademarks, record the attached original documents or copy thereof.

1. Name of conveying party(ies):

Klementina Khait
Erin G. RiddickAdditional name(s) of conveying party(ies) attached? ☐ Yes ☒ No

3. Nature of conveyance:

☒ Assignment☐ Merger☐ Security Agreement☐ Change of Name☐ Other _____

Execution Date: July 7, 2000

2. Name and address of receiving party(ies)

Name: Material Sciences Corporation

Internal Address: _____

Street Address: 2200 East Pratt Blvd.

Elk Grove
City: Village State: IL ZIP: 60007-5995Additional name(s) & address(es) attached? ☐ Yes ☐ No

4. Application number(s) or patent number(s):

If this document is being filed together with a new application, the execution date of the application is: 8/8/00

A. Patent Application No.(s)

B. Patent No.(s)

09635473

Additional numbers attached? ☐ Yes ☒ No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: Stuart D. Frenkel, Esq.

Internal Address: _____

Liniak, Berenato, Longacre &
Street Address: White

6550 Rock Spring Drive, Ste. 240

City: Bethesda State: MD ZIP: 20817

6. Total number of applications and patents involved:

1

7. Total fee (37 CFR 3.41).....\$ 40.00

☒ Enclosed☐ Authorized to be charged to deposit account

8. Deposit account number:

50-0548

(Attach duplicate copy of this page if paying by deposit account)

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9. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Stuart D. Frenkel, Esq.
Name of Person Signing

Signature

8/10/00

Date
6313.150

Total number of pages including cover sheet, attachments, and document:

4

Mail documents to be recorded with required cover sheet information to:
Commissioner of Patents & Trademarks, Box Assignments
Washington, D.C. 20231

PATENT

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ASSIGNMENT

In consideration of One Dollar and other good and valuable consideration, receipt of which is hereby acknowledged, we Klementina Khait, an individual residing at 5240 Cleveland, Skokie, Illinois 60077 and Erin G. Riddick, an individual residing at 3604 N. Bosworth Road, Apt. 1, Chicago, Illinois 60613 ("Assignors") hereby sell, assign, transfer and set over all right, title, and interest in the invention entitled, SOLID STATE SHEAR PULVERIZATION OF MULTICOMPONENT POLYMERIC WASTE to Material Sciences Corporation, a corporation of the State of Delaware, having its principal place of business at 2200 East Pratt Boulevard, Elk Grove Village, Illinois 60007-5995 ("Assignee"), its successors, assigns, nominees, or other legal representatives, the entire right, title and interest in all countries foreign to the United States of America including the priority rights derived from the herein designated applications for Letters Patent by virtue of the International Convention for the Protection of Industrial Property for any and all member countries of the aforesaid International Convention together with all rights, including the sole rights under the aforesaid International Convention to apply for and obtain Letters Patent for said invention or inventions in all countries of the world

other than the United States of America, including original, divisional, continuation, continuation-in-part, reissue, utility and design patents, patents of addition, confirmation patents, registration patents, petty patents, utility models, etc., and all other types of patents and the like, and all renewals and extensions of any of them, and the entire right, title and interest in and to all such Letters Patent, the applications therefor and the subject matter of all claims obtained in said Letters Patent, and authorize and request any official of any country or countries foreign to the United States whose duty it is to issue Letters Patent on applications as aforesaid to issue the said Letters Patent to the said Material Sciences Corporation, its successors, assigns, nominees or other legal representatives, as assignee of the entire interest, and covenant that we have full right to convey the entire interest herein assigned and that we have not executed and will not execute any agreement in conflict herewith.

Assignor further covenant and agree that whenever requested by said Material Sciences Corporation, its successors, assigns, nominees or legal representatives, we will execute and deliver or cause to be executed and delivered such further patent applications, assignments, oaths, disclaimers and other documents, give or cause to be given such evidence and furnish or

cause to be furnished such information within our knowledge or control, and do or cause to be done such other acts and furnish or cause to be furnished such other assistance, as it may deem necessary or desirable in connection with obtaining and/or maintaining any Letters Patent as aforesaid for said invention or inventions, or in connection with any suit or controversy, including interference proceedings, relating to any of such Letters Patent or to any applications therefor or in order to vest or perfect in it or in any of them or to protect or enforce the right, title and interest herein assigned, or otherwise to effectuate the premises, all without further consideration but at the expense of said Material Sciences Corporation, its successors, assigns, nominees or legal representatives.

Dated: 7/7/00

K. Khait
Klementina Khait

Dated: 7/7/00

Erin G. Riddick
Erin G. Riddick